

WSJM65R600 Super-Junction Power MOSFET

Rev.01 - 22 January 2024

**Product data sheet** 

### 1. General description

WSJM65R600 is a high voltage N-channel MOSFET in TO220 package, which utilizes the advanced super-junction technology to provide superior FOM  $R_{DS(on)} * Q_g$  among silicon based MOSFETs. It is particularly suitable for applications require extreme high efficiency and power density.



## 2. Features and benefits

- Superior FOM R<sub>DS(on)</sub> \* Q<sub>g</sub>
- Extremely low switching loss
- 100% avalanche tested

## **3. Applications**

- PFC stage and/or DC/DC converters in various high efficiency power suppliers, e.g. TV/sever/telecom/lighting power suppliers
- Inverters and motor drives

## 4. Quick reference data

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Table 1. Qu	lick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
V <sub>DS</sub>	drain-source voltage				650		V
$V_{GS}$	gate-source voltage				±30		V
I <sub>D</sub>	continuous drain current	T <sub>mb</sub> = 25 °C			8.0		А
P <sub>tot</sub>	power dissipation	T <sub>mb</sub> = 25 °C		96		W	
T <sub>j</sub>	junction temperature			-55 to 150		°C	
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics					Ì	
$R_{\text{DS(on)}}$	drain-source on-state resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 3.5 A		-	522	600	mΩ
Dynamic	characteristics	^					·
Q <sub>G(tot)</sub>	total gate charge	$I_{\rm D}$ = 3.5 A; $V_{\rm DS}$ = 400 V; $V_{\rm GS}$ = 10 V		-	12	-	nC
E <sub>oss</sub>	coss stored erergy	$V_{GS} = 0 V; V_{DS} = 0 to 400 V$		-	1.8	-	μJ

# **5. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate	mb	D
2	D	drain		
3	S	source		
mb	D	mounting base; connected to drain		svm300 S

## 6. Ordering information

Table 3. Ordering information								
Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WSJM65R600	TO220	WSJM65R600Q	Tube	50	SOT78	13-Jun-2008		

# 7. Marking

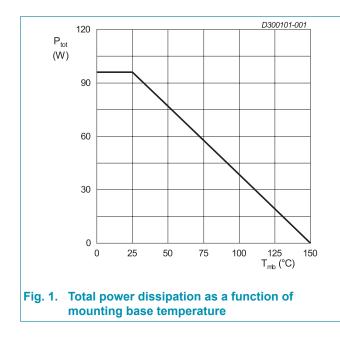
Table 4. Marking codes						
Type number	Marking codes					
WSJM65R600	WSJM 65R600					

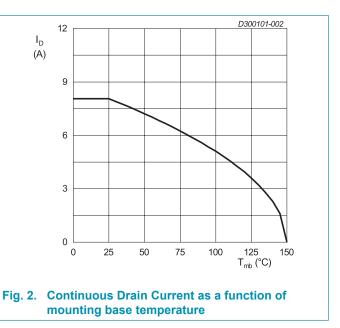
# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>DS</sub>	drain-source voltage			650	V
V <sub>GS</sub>	gate-source voltage			±30	V
I <sub>D</sub>	continuous drain current	T <sub>mb</sub> = 25 °C		8.0	А
		T <sub>mb</sub> = 100 °C		5.1	А
I <sub>DM</sub>	pulsed drain current	T <sub>mb</sub> = 25 °C		22	А
P <sub>tot</sub>	power dissipation	T <sub>mb</sub> = 25 °C		96	W
E <sub>AS</sub>	single pulse drain-to- source avalanche	$I_{AS}$ = 2.1 A; R <sub>GS</sub> = 25 Ω; V <sub>DD</sub> = 50 V; T <sub>j</sub> = 25 °C		22	mJ
E <sub>AR</sub>	repetitive avalanche energy	$I_{AS} = 2.1 \text{ A}; \text{ R}_{GS} = 25 \Omega; \text{ V}_{DD} = 50 \text{ V};$ $T_j = 25 \text{ °C}$		0.5	mJ
I <sub>AS</sub>	avalanche current, single pulse			2.1	A
dv/dt	MOSFET dv/dt ruggedness			50	V/ns
dv/dt	reverse diode dv/dt			15	V/ns
dl <sub>F</sub> /dt	maximum diode commutation speed			500	A/µs
T <sub>stg</sub>	storage temperature			-55 to 150	°C
Tj	junction temperature			-55 to 150	°C

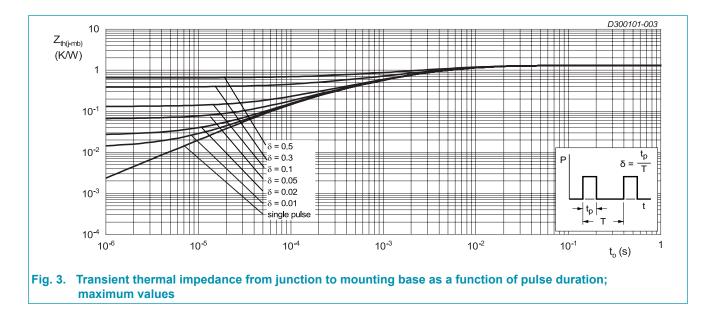




## 9. Thermal & Mechanical characteristics

#### Table 6. Thermal & Mechanical characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base			-	0.97	1.3	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air		-	60	-	K/W



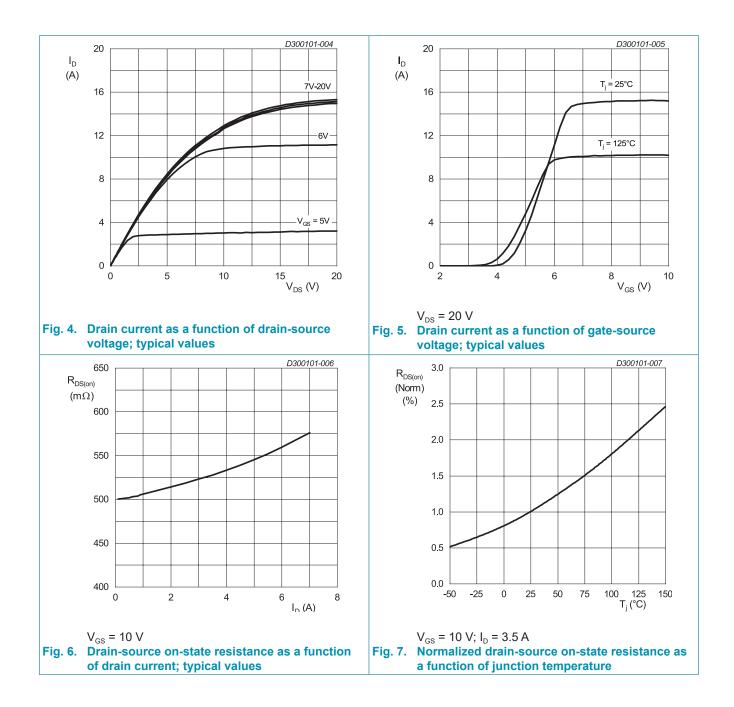
## **10. Characteristics**

### Table 7. Characteristics

### $T_j$ = 25 °C unless otherwise noted

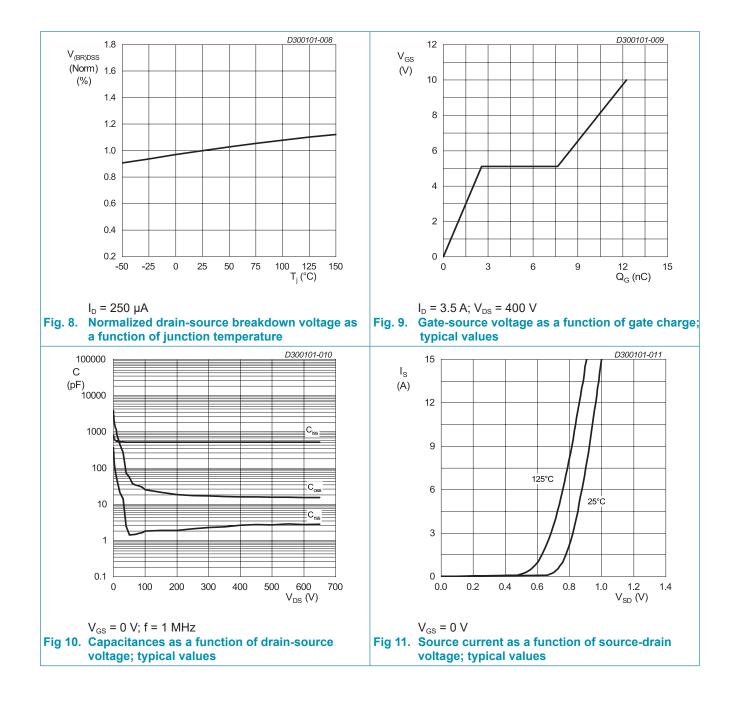
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	aracteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_{D}$ = 250 µA; $V_{GS}$ = 0 V		650	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 250 \ \mu\text{A}; \ V_{DS} = V_{GS}$		2.5	-	4.5	V
I <sub>DSS</sub>	drain leakage current	$V_{\rm DS}$ = 650 V; $V_{\rm GS}$ = 0 V		-	-	1	μA
		$V_{DS}$ = 650 V; $V_{GS}$ = 0 V; $T_j$ = 125 °C		-	-	10	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$		-	-	±100	nA
$R_{\text{DS(on)}}$	drain-source on-state resistance	$V_{GS}$ = 10 V; I <sub>D</sub> = 3.5 A		-	522	600	mΩ
R <sub>G</sub>	gate resistance	f = 1 MHz		-	8.5	-	Ω
Dynamic	characteristics						
Q <sub>G(tot)</sub>	total gate charge	$I_{D}$ = 3.5 A; $V_{DS}$ = 400 V; $V_{GS}$ = 10 V		-	12	-	nC
$Q_{GS}$	gate-source charge			-	2.6	-	nC
$Q_{GD}$	gate-drain charge			-	5.1	-	nC
C <sub>iss</sub>	input capacitance	V <sub>DS</sub> = 400 V; V <sub>GS</sub> = 0 V; f = 1 MHz		-	520	-	pF
C <sub>oss</sub>	output capacitance			-	16	-	pF
C <sub>rss</sub>	reverse transfer capacitance			-	2.6	-	pF
$C_{o(er)}$	effective output capacitance, energy related	$V_{GS}$ = 0 V; $V_{DS}$ = 0 to 400 V		-	22	-	pF
C <sub>o(tr)</sub>	effective output capacitance, time related			-	90	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS} = 400 \text{ V}; V_{GS} = 10 \text{ V}; \text{ R}_{G} = 2 \Omega;$		-	18	-	ns
t <sub>r</sub>	rise time	$I_{\rm D} = 3.5  {\rm A}$		-	14	-	ns
t <sub>d(off)</sub>	turn-off delay time			-	30	-	ns
t <sub>f</sub>	fall time			-	16	-	ns
Source-d	rain diode						
V <sub>SD</sub>	source-drain voltage	V <sub>GS</sub> = 0 V; I <sub>S</sub> = 3.5 A		-	0.8	1.1	V
l <sub>s</sub>	body-diode continuous current	T <sub>mb</sub> = 25 °C		-	-	8.0	A
t <sub>rr</sub>	reverse recovery time	$V_{\textrm{R}}$ = 400 V; I_{\textrm{F}} = 3.5 A; dI_{\textrm{F}}/dt = 100 A/µs		-	182	-	ns
Q <sub>rr</sub>	reverse recovered charge			-	1.5	-	μC
l <sub>rrm</sub>	reverse recovery current			-	15	-	А

**Super-Junction Power MOSFET** 

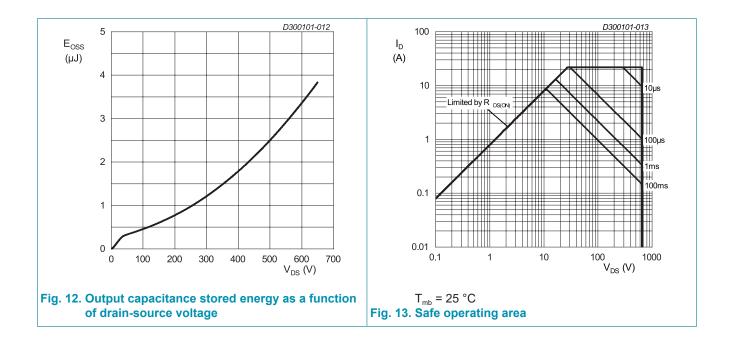


## WSJM65R600

### **Super-Junction Power MOSFET**



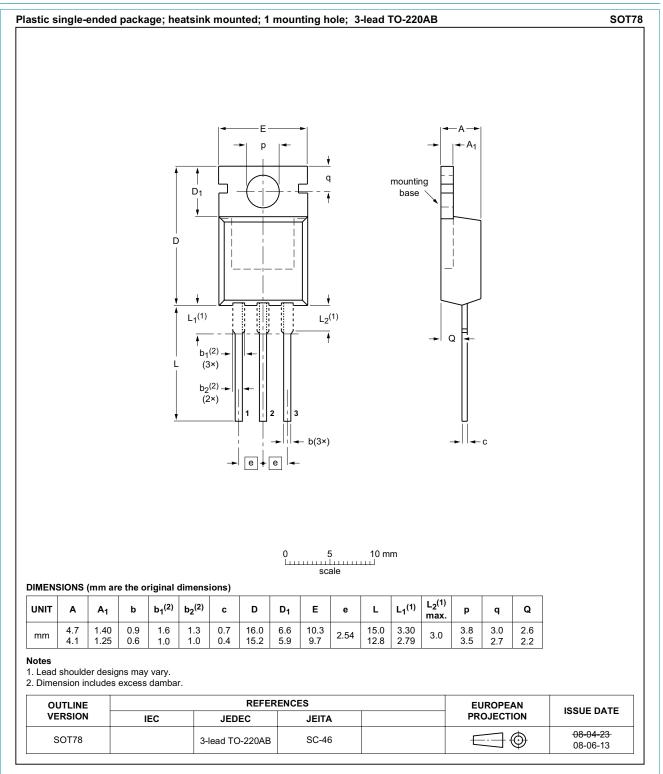
### WSJM65R600 Super-Junction Power MOSFET



# WSJM65R600

Super-Junction Power MOSFET

## **11. Package outline**



WSJM65R600 Product data sheet

# WSJM65R600

#### **Super-Junction Power MOSFET**

## 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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